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



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Cohesive zone modelling of anodic dissolution stress corrosion cracking induced by corrosion product films

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ABSTRACT

Damage mechanics based on the cohesive zone model were applied to study the anodic dissolution stress corrosion cracking (SCC) in flat and U-shaped edge-notched specimens. The simulation results show that corrosion product films (CPF) facilitate crack initiation in SCC due to the CPF-induced stress and CPF rupture. In the flat specimen, SCC susceptibility increases with the CPF thickness and CPF Young's modulus, while it decreases with CPF fracture strength. For the U-shaped edge-notched specimen, the normalised threshold stress intensity factor K_{ISCC}/K_{IC} decreases with the CPF thickness and notch depth.

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FEM; cohesion; corrosion; cracking; films; stress corrosion cracking; corrosion product films

1. Introduction

Corrosion product films (CPFs), such as passive films, oxide films or de-alloyed layers, usually form on the surfaces of a specimen and/or at the crack tip during anodic dissolution stress corrosion cracking (SCC). A number of experimental results have shown that the CPFs play a critical role in the initiation and propagation of stress corrosion cracks [1–6]. Kermani et al. [1] observed that the SCC of α -brass in ammoniacal solution can be arrested by the formation of the tarnish film at the crack tip. The stress is applied to rupture the tarnish film and to maintain it in the ruptured condition, such that the metal/environment reaction causing cracking can proceed. Forty et al. [2] studied the fracture mode of a specimen with the tarnish surface layer and correlated the occurrence of a subsequent localised chemical attack when the specimen with cracked tarnish surface was replaced in the solution. By alternatively tarnishing a brass specimen

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and deforming it under tension, transgranular SCC cracks were observed to propagate into the ductile specimen. Newman et al. [3] proposed the film-induced cleavage model based on the observation that a crack originating in the surface layer can penetrate into the underlying ductile metallic substrate by several micrometers. Zhang et al. [4] and Du et al. [5] found that hydrogen and pre-strain facilitated anodic dissolution of brass in the Mattsson's solution and increased the corrosion product film (CPF) growth rate, and the CPF-induced stress would ultimately result in an enhancement of CPF rupture and SCC susceptibility. All these results experimentally proved that the formation and rupture of CPF was a prerequisite for the anodic dissolution SCC.

Mechanical properties of the CPF were also considered as a dominant factor of the SCC process. Systematic studies have shown that the CPF can induce tensile stress at the interface between the matrix metal and the CPF during SCC. The CPF-induced stress dependences on the anion concentration [7] and pH value of the solution [8] and the applied potential [9], and hydrogen content in the specimens [10] were in good agreement with the SCC susceptibility under slow strain rate test (SSRT). In other words, under various experimental conditions, larger CPF-induced tensile stress resulted in higher SCC susceptibility. When the CPF-induced stress changes from tensile to zero or compressive under certain circumstances, the SCC ceases [9]. The same behaviour was observed in many SCC systems, such as α -Ti in methanol [9], stainless steel in boiling MgCl_2 [11], brass and copper in ammoniacal solution [5] and low alloy steel in marine environments [12]. Based on this experimental evidence, many researchers have concluded that the CPF-induced stress plays a crucial role in SCC [7,13].

Several studies have modelled crack initiation with an idealised traction separation law. The cohesive zone model (CZM) represents the behaviour of the fracture process zone and describes the relationship between cohesive tractions and separations across the cohesive crack surfaces. To date, the CZM techniques have been developed to simulate the fracture behaviour of a wide range of materials systems. In fracture modelling, CZM has found wide applications and received a lot of modifications and developments [14–20]. In recent years, CZM techniques have been also applied to simulate crack propagation in hydrogen embrittlement [21–27]. Serebrinsky et al. [21] presented the model of hydrogen embrittlement based on the cohesive law and reproduced experimental trends. Scheider et al. [22] studied the effects of hydrogen diffusion on stable crack propagation by using finite element simulations based on the cohesive model for hydrogen-assisted stress corrosion cracking. Olden et al. [23] performed diffusion and cohesive zone-based fracture initiation analysis of notched rectangular tensile specimens of 25% Cr stainless steel for hydrogen-induced stress cracking. Alvaro et al. [24] performed experiments with crack initiation of hydrogen-induced fracture using the same cohesive zone model approach. In this paper, a CZM is developed and employed to investigate the

effects of the CPF on crack initiation in anodic dissolution SCC. The effects of the CPF thickness, CPF Young's modulus, and CPF-induced stress on the initiation of the SCC, SCC susceptibility and threshold stress intensity factor are discussed.

2. Materials data and CZM procedures

Not annealed copper substrate with Young's modulus $E_s = 130$ GPa, yield stress $\sigma_{ys} = 350$ MPa and a Poisson's ratio of 0.3 was used in this simulation study. The Young's modulus of the elastic CPF varied from $E_f = 0.2E_s$, $0.5E_s$, E_s to $1.5E_s$ and the CPF thicknesses $t_f = 0.0005$, 0.001 , 0.002 , 0.006 , 0.01 mm was used. To simulate the CPF-induced stress, the CPF was assigned with a positive thermal expansion coefficient, while for the metallic substrate it was assumed to be zero. It should be noted that similar method has been used to introduce the residual stresses induced by elastic anisotropy [28–30] and welding process [31,32], in which the thermal expansion coefficients had no specific physical meaning. Experimental results have demonstrated that 1 to 1.5 GPa compressive stress could be generated in the tarnish film of copper in ammoniacal solution during SCC [33]. A suitable expansion coefficient was selected to generate the stress in the CPF and the substrate at a unit temperature increment $\Delta T = 1^\circ\text{C}$.

Two-dimensional finite element models of flat and U-shaped edge-notched specimens under tension were created. The specimen was loaded by a remote displacement. The cracking was modelled by the CZM in ABAQUS/CAE. The cohesive elements were located in the middle of the model, schematically shown in Figure 1, with a very small initial thickness $T_c = 10^{-5}$ mm. A 2D plane strain model was constructed with the CPE4 and COH2D4 elements. The boundary conditions were as follows:

$$x = 0, U_x = U_y = 0 \quad (1)$$

$$x = l_0, U_x = D, U_y = 0 \quad (2)$$

The global and local meshes of the U-shaped edge-notched specimen with a CPF are shown in Figure 2. When the notch and CPF dimensions change, the mesh density around the notch is slightly altered to ensure consistency in the size of the elements created around the notch, which indicates that the meshes created for the cases with different notch sizes will not be completely identical, but should yield similar levels of accuracy.

All the micromechanical damage processes that occur within the process zone are embodied in the cohesive zone law. The CZM is characterised by the traction-separation law [34]. The law can be expressed with the crack opening displacement δ and the critical traction σ . The cohesive element behaviour is assumed to be linear-elastic initially until the critical traction/displacement

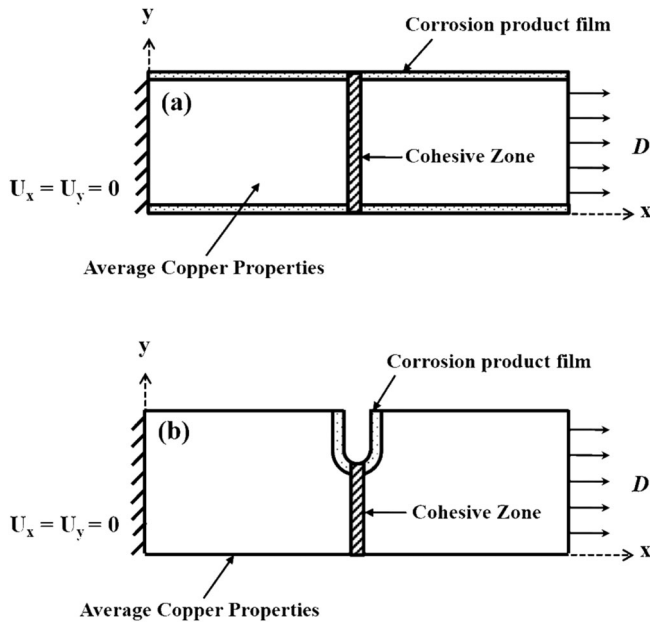


Figure 1. Schematics of the cohesive zone and the boundary conditions. The dimensions of the cohesive zone are exaggerated for clarity: (a) the flat specimen and (b) the U-shaped edge-notched specimen.

has been reached. The triangular cohesive law where the traction after the peak is a decreasing linear function of the opening distance between the upper and lower surfaces of the cohesive elements is commonly used in the literature and is available in ABAQUS/CAE and is also employed in the current study, as shown in Figure 3. Crack initiation is defined as the achievement of zero stress and critical opening in the first cohesive element.

However, the values of these CZM parameters are usually not known and cannot be measured directly from experiments. There are yet no well-established universal rules for determining the values of the CZM parameters.

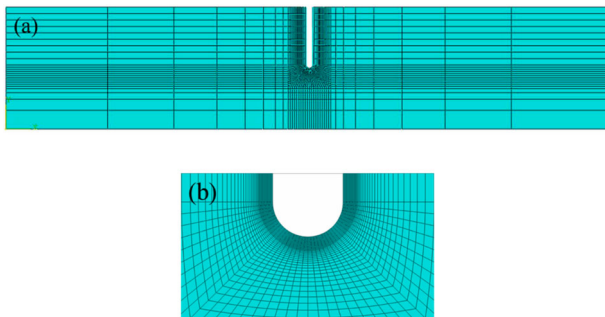


Figure 2. The meshes of the U-shaped edge-notched specimen covered by a CPF: (a) the global and (b) local meshes.

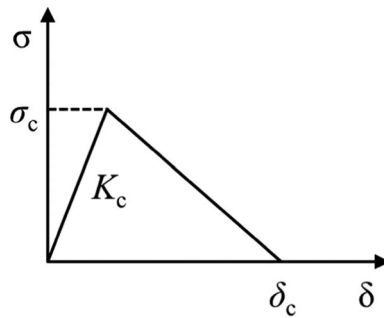


Figure 3. Triangular traction-separation law used in the analysis.

The two basic parameters necessary to describe the traction-separation law are the critical traction and the critical separation. The fracture energy is computed by means of the relation $G_c = K_{IC}^2 / (E / (1 - \nu^2)) = 1/2(\sigma_c \delta_c)$ under plane strain, in which K_{IC} of $17 \text{ MPa}\sqrt{m}$ [35] is used for copper. After a systematic parameter study, we have chosen a parameter set ($\sigma_c^{\text{sub}} = 425 \text{ MPa}$, $\delta_c^{\text{sub}} = 0.00952 \text{ mm}$) for the substrate to ensure that copper tension in the air is controlled by plastic necking and not by brittle rupture. For $\sigma_c^{\text{sub}} < 425 \text{ MPa}$, the cohesive element will cause damage and induce brittle fracture. The fracture strain (or elongation) of copper in the air is taken from our experiments and the value is about 5.38%. For SCC, the fracture behaviour is brittle. For the CPF, composed of corrosion porous layer in which the vacancy groups and holes exist, the fracture strength should be lower than the copper substrate. Although the data of the fracture strength of the CPF are not found, a basic value of 300 MPa was used as the critical cohesive traction of the CPF. Other values are discussed in terms of the CPF fracture strength. To make sure that the CPF fails in a brittle manner, the basic value of $\delta_c^{\text{CPF}} = 0.008 \text{ mm}$ was chosen as the critical crack opening displacement of the CPF. The sensitivity of simulation depends on the chosen value of the CPF cohesive parameter (δ_c^{CPF}), which is discussed first. Figure 4 shows the effect of the CPF opening displacement δ_c^{CPF} on SCC susceptibility in a flat specimen with different CPF properties. It can be seen that when the δ_c^{CPF} increases from 0.005 mm to 0.009 mm, the SCC susceptibility (see the definition below) reduces linearly, but only to about 0.15% maximum. In addition, in the analysis with CZM, a large value of the interface stiffness is necessary to assure correct representation of the system behaviour before the crack initiation. The stiffness of the cohesive zone, k_s , is chosen as $3.5 \times 10^5 \text{ MPa/mm}$. During the simulation of the cracking by cohesive elements, convergence problem occurs, especially in the model with CPF. A small viscosity ν of 10^{-5} MPa s [36] in the cohesive law in combination with the use of a small-step increment in the simulations, improves the convergence rate. All the input parameters for the cohesive zone modelling are presented in Table 1.

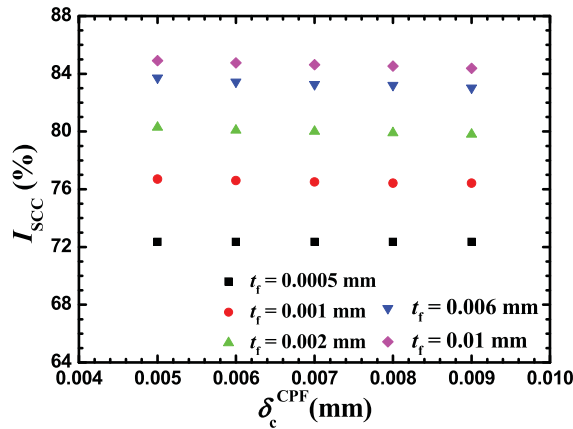


Figure 4. Effect of the critical opening displacement of CPF, δ_c^{CPF} , on the calculated SCC susceptibility based on the cohesive zone modelling with various CPF thickness and $E_f/E_s = 0.5$, and $\sigma_c^{CPF} = 300$ MPa.

3. Results and discussion

3.1. SCC susceptibility of the flat specimens

For the flat specimen, SCC susceptibility is defined as $I_{SCC} = (1 - \varepsilon_{FSCC}/\varepsilon_F) \times 100\%$, where ε_F and ε_{FSCC} are the fracture strain (or elongation) of the flat specimens in the air and in the solution, respectively. The flat specimen with a CZM covered with a CPF is used to simulate the stress–strain curves of the specimens in solution. ε_{FSCC} is estimated from the simulated fracture strain of the flat specimen covered by the CPF. The simulation results of the stress–strain curve of the flat specimen with CPF of various thicknesses, Young’s modulus ratio and fracture strength (which is presented by σ_c^{CPF}), are shown in Figure 5(a–c), respectively. Figure 5(a) depicts the effects of the CPF thickness on the simulated stress–strain curves. It is clearly shown that the yield stress and the fracture strain/elongation decrease with the CPF thickness. Figure 5(b) summarises the dependence of the fracture strain/elongation on the Young’s modulus ratio between the CPF Young’s modulus (E_f) and the copper substrate Young’s modulus (E_s). It can be seen that the fracture strain/elongation decrease with the CPF Young’s modulus. These results correspond with our previous studies of the CPF-induced stress in flat specimens [32,37]. Tensile CPF-induced stress is generated [33] in the metallic substrate during SCC, and the peak stress localises at the interface between the CPF and the metallic substrate on the substrate side. The CPF-

Table 1. Input parameters for the cohesive zone modelling [36].

σ_c^{sub} , MPa	δ_c^{sub} , mm	σ_c^{CPF} , MPa	δ_c^{CPF} , mm	k_s , MPa/mm	ν , MPa·s
425	0.00953	300 ^a	0.008	3.5×10^5	0.00001

^aOther values were also employed to discuss the CPF fracture strength.

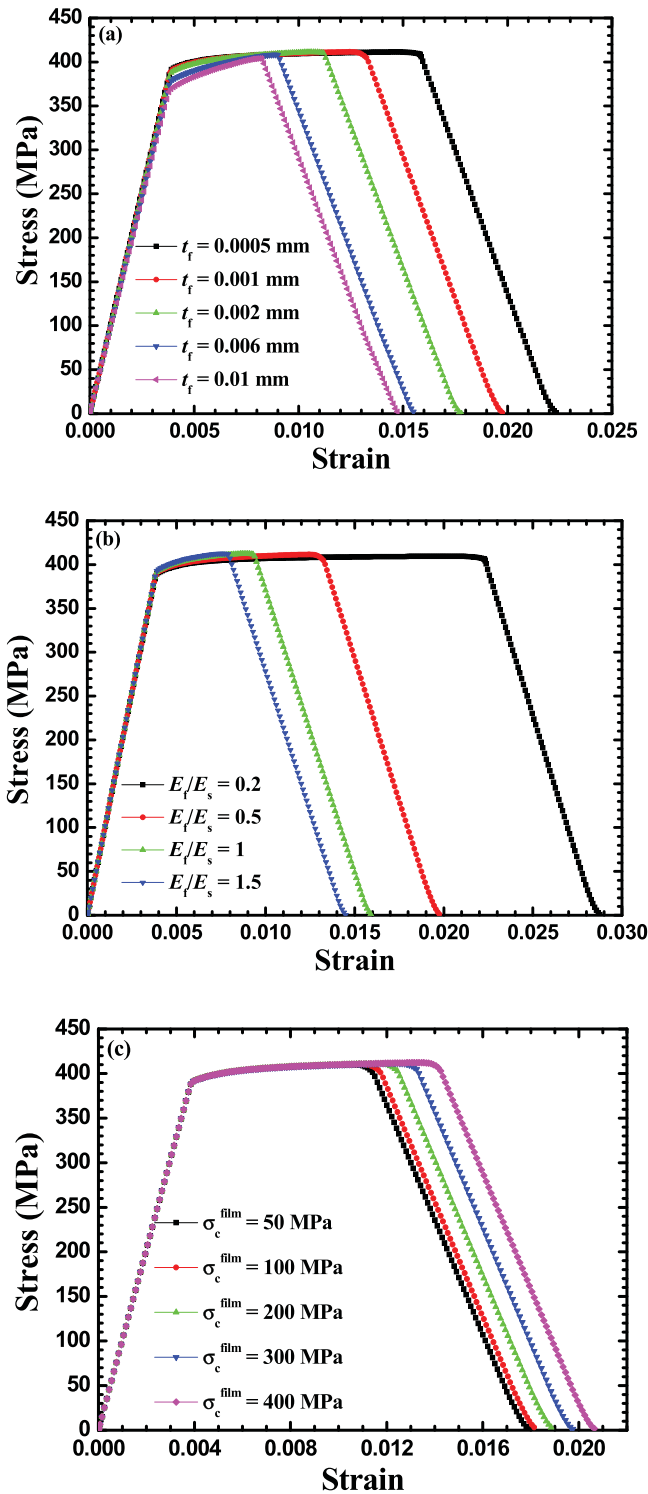


Figure 5. Stress-strain curves obtained from the cohesive zone modelling of the flat specimen with and without CPF with: (a) various CPF thickness and $E_f/E_s = 0.5$, and $\sigma_c^{\text{CPF}} = 300$ MPa; (b) various CPF Young's moduli with $t_f = 0.001$ mm and $\sigma_c^{\text{CPF}} = 300$ MPa; (c) various CPF fracture strengths with $t_f = 0.001$ mm and $E_f/E_s = 0.5$.

induced stress increases with the CPF thickness and the CPF Young's modulus [37]. The CPF-induced tensile stress is superimposed on the applied load to deform and fracture the specimens, resulting in the reduction of the yield stress of the substrate (as shown in Figure 5(a)), and the fracture strain (shown in Figure 5(a,b)).

The effect of CPF fracture strength (critical traction σ_c^{CPF}) on the stress–strain curve of the flat specimen is shown in Figure 5(c). The fracture strain increases with σ_c^{CPF} . The higher the CPF fracture strength, the harder stress corrosion crack initiation is. Thereby it can be concluded that the high CPF-induced tensile stress and low CPF fracture strength leads to small fracture strain, i.e. high susceptibility to SCC.

Variations of I_{SCC} calculated based on Figure 5 for various CPF thickness, Young's modulus ratio E_f/E_s and CPF fracture strength are shown in Figure 6 (a,b), respectively. With the increase of the CPF thickness and CPF Young's modulus, the I_{SCC} increases, while lower CPF fracture strength results in higher I_{SCC} . The CPF fracture strength is more obvious for thicker CPF. From Figure 6, it can be concluded that CPF can reduce the fracture strain/elongation, while thicker and harder CPF results in higher CPF-induced stress, thus the fracture strain/elongation decreases, and the SCC susceptibility I_{SCC} increases. All these results clearly show that cracks initiate more easily with CPF in SCC.

3.2. SCC susceptibility of the U-shaped edge-notched specimen

For the U-shaped edge-notched specimen, the fracture toughness K_{IC} can be calculated based on $K_{\text{IC}} = YP_Q\sqrt{\pi a}/(BW)$, where $Y = 1.12 - 0.23(a/w) + 10.6(a/w)^2 - 21.7(a/w)^3 + 30.4(a/w)^4$, and a , B , and W are crack length (or notch depth), specimen thickness and width, and P_Q is the critical load corresponding to the relative crack extension $\Delta a/a = 2\%$. During SSRT in the solution where the CPF forms, the critical stress intensity factor corresponding to SCC extension $\Delta a/a = 2\%$ is defined as the threshold stress intensity factor, K_{ISCC} , i.e. $K_{\text{ISCC}} = YP_{\text{QSCC}}\sqrt{\pi a}/(BW)$. Lower K_{ISCC} results in easier SCC. The load-displacement curves obtained from the CZM modelling of the U-shaped edge-notched specimen with and without CPF (simulating SCC in the solution) are shown in Figure 7(a). K_{IC} and K_{ISCC} can be calculated based on Figure 7(a). Figure 7(b,c) shows variations of the normalised threshold stress intensity factor $K_{\text{ISCC}}/K_{\text{IC}}$ with the CPF thickness, Young's modulus ratio, and notch depth.

From Figure 7(a), one can calculate P_Q or P_{QSCC} from the intersection of the line OP_Q or OP_{QSCC} and the curve, where the slope of the line OP_Q or OP_{QSCC} is 5% less than the elastic straight line, corresponding to the relative crack extension $\Delta a/a = 2\%$. The normalised threshold stress intensity factor $K_{\text{ISCC}}/K_{\text{IC}}$ shown in Figure 7(b,c) can be obtained based on Figure 7(a). $K_{\text{ISCC}}/K_{\text{IC}}$ decreases with the CPF thickness, while it is not a strong function of the Young's modulus of the CPF. This reveals that a thick CPF can increase K_{ISCC}

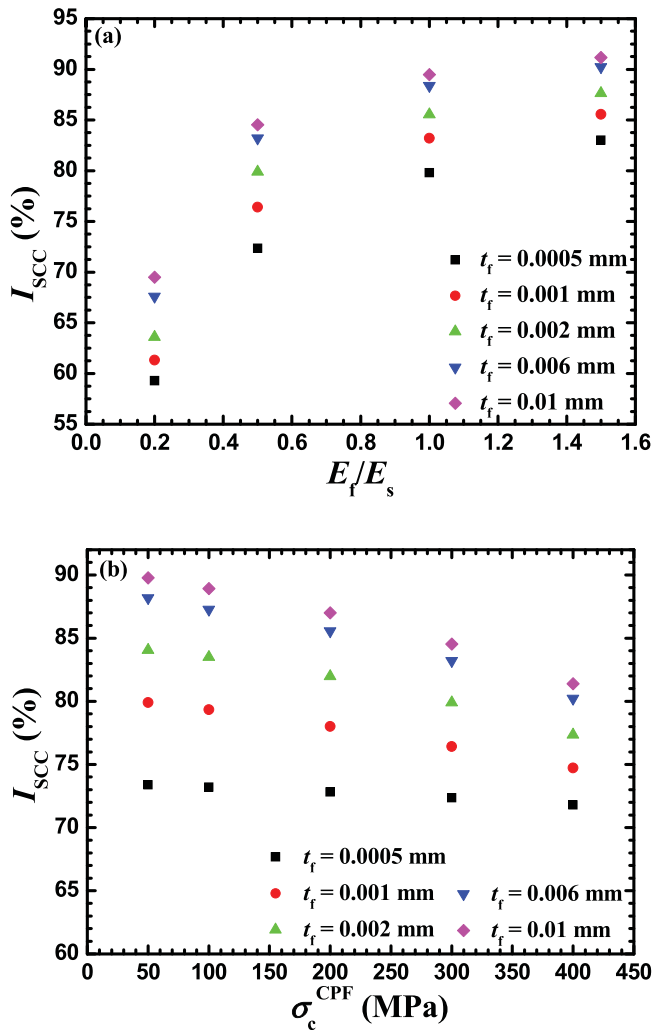


Figure 6. Calculated SCC susceptibility based on the cohesive zone modelling with: (a) various CPF thickness and Young's modulus ratio E_f/E_s for the CPF with $\sigma_c^{CPF} = 300$ MPa, and (b) various CPF fracture strengths of the CPF with Young's modulus ratio $E_f/E_s = 0.5$.

or decrease SCC susceptibility. Thereby large CPF-induced stress leads to small K_{ISCC} and high SCC susceptibility. The effect of notch depth on the normalised K_{ISCC}/K_{IC} is shown in Figure 7(c), where K_{ISCC}/K_{IC} decreases with the notch depth. It can be concluded that the normalised K_{ISCC}/K_{IC} ratio decreases with the notch depth. This means that the crack initiates easier in SCC.

The fracture in SCC is brittle and the crack usually initiates in the CPF. In the flat and U-shaped edge-notched specimens, the crack initiation occurs in the CPF first. Once the crack initiates, it is equivalent to forming a small notch and leads to a stress concentration in the substrate. This will cause quick fracture of the substrate. Thereby, in the anodic dissolution SCC system, the rupture of the CPF is the dominant factor for SCC. Furthermore, the rupture of the CPF is

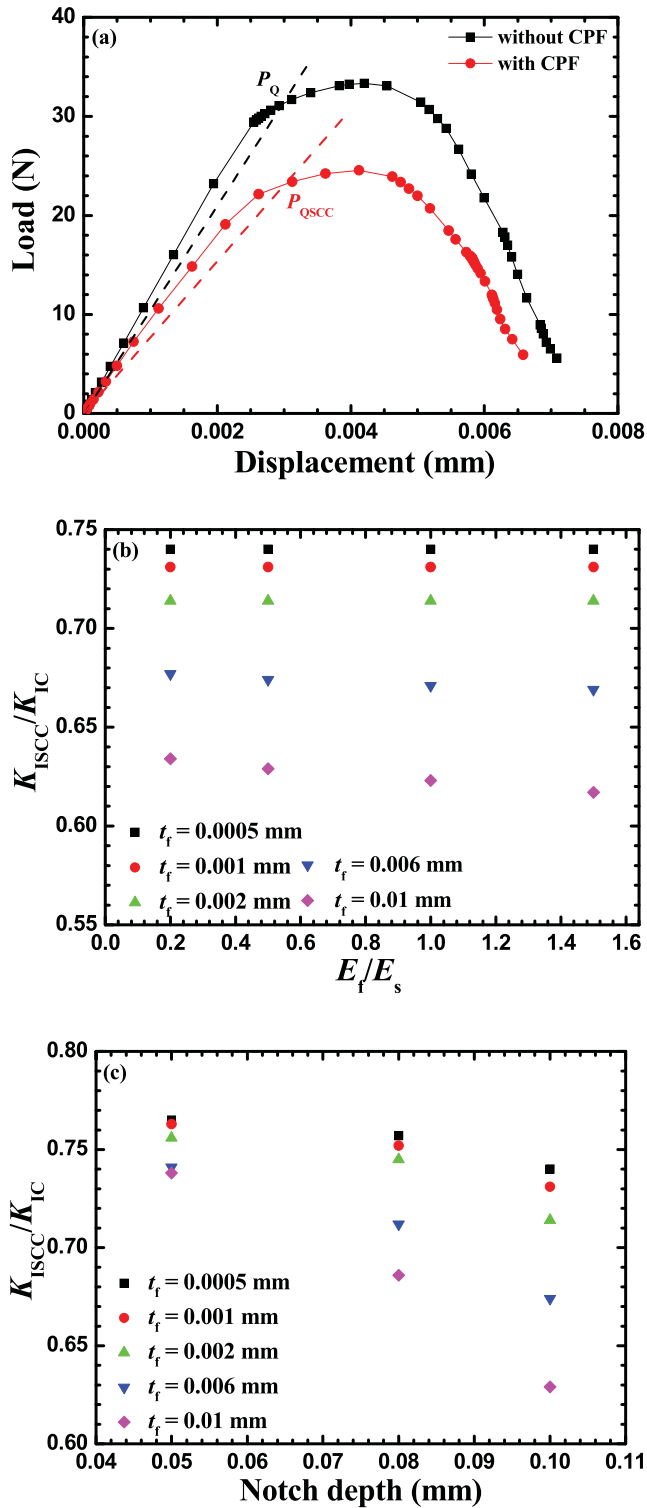


Figure 7. (a) P_Q and P_{QSCC} in the load-displacement curve of the U-shaped edge-notched specimen, and the variation of the normalised threshold stress intensity factor (K_{ISCC}/K_{IC}) with: (b) various Young's modulus ratio E_f/E_s and CPF thicknesses for the notch depth of 0.1 mm; (c) various notch depths and CPF thicknesses for the CPF Young's modulus ratio $E_f/E_s = 0.5$.

controlled by the CPF fracture strength. It can be concluded the CPF fracture strength is significant for SCC.

4. Conclusions

A cohesive zone model is developed and applied to anodic dissolution stress corrosion cracking to simulate crack initiation in flat and U-shaped edge-notched specimens. Corrosion product film facilitates the stress corrosion crack initiation in the flat and U-shaped edge-notched specimens because of the existence of the CPF-induced stress. In the flat specimen, SCC susceptibility I_{SCC} increases with the decrease of the CPF fracture strength and the increase of the CPF thickness and the CPF Young's modulus. In the U-shaped edge-notched specimen, it is found that the normalised threshold stress intensity factor (K_{ISCC}/K_{IC}) decreases with the CPF thickness and the notch depth. Crack initiation occurs first in the CPF and then propagates into the substrate.

Disclosure statement

No potential conflict of interest was reported by the authors.

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